

N-Channel Enhancement Mode MOSFET

Primary characteristics							
Symbol	Parameter	Value	Unit				
١ _D	Continuous drain current (@T₃=25°C)	6.2	А				
V _{DS}	Drain source voltage	20	V				
R _{DSON} @V _{GS} =4.5V, I _D =4.5A	Static drain-source on- resistance	<25 Typ. 19.4	mΩ				

Features

- SOT-23 case for easy automatic insertion
- Pb-free and RoHS compliant
- Advanced trench process technology
- High density cell design for ultra low on-resistance

Application

- Load switch
- DC/DC converter
- Switching circuits
- Power management

Case dimensions						
1 – Gate: 2 – Source: 3 - Drain						

1 – Gate; 2 – Source; 3 - Drain

SOT-23 (TO-236AB)													
Unit	Α	A ₁ max	b _p	с	D	Е	е	eı	HE	Lp	Q	v	w
mm	1.0 ±0.1		0.43 ±0.05				1.9	0.95			0.5 ±0.05		0.1

Absolute maximum ratings (T _A = 25°C unless otherwise noted)							
Characteristic	Symbol	Value	Unit				
Drain-source voltage	V _{DS}	20	V				
Gate-source voltage	V _{GS}	±12	V				
Continuous drain current	lo	6.2	А				
Pulsed drain current ¹⁾	I _{DM}	24.8	А				
Power Dissipation ²⁾	PD	1.56	W				
Operating junction temperature range	TJ, TSTG	-50 ~ 175	°C				
Thermal resistance junction-ambient ²⁾	R _{eJA}	80	°C/W				



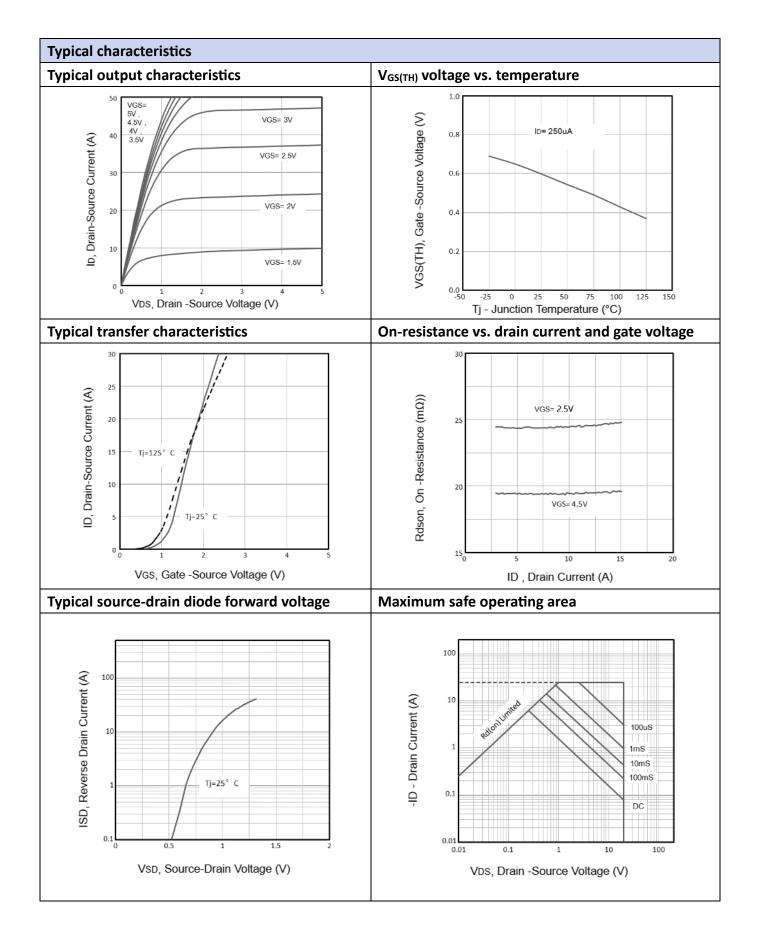
Oh ann at an iat ia		C. m. h. l		Value		Unit
Characteristic	Test condition	Symbol	Min.	Тур.	Max.	
Drain-source breakdown voltage	V _{GS} =0V, I _D =250μA	V(BR)DSS	20	-	-	V
Drain-source leakage current	V _{DS} =20V, V _{GS} =0V	I _{DSS}	-	-	1.0	μΑ
Gate-source leakage current	V _{GS} =±10V, V _{DS} =0V	Igss	-	-	±100	nA
Gate threshold voltage	V _{DS} =V _{GS} , I _D =250µA	V _{GS(TH)}	0.45	0.6	1.0	V
Drain-source on-state resistance ³⁾	V _{GS} =4.5V, I _D =4.5A	D	-	19.4	25	mΩ
Dram-source on-state resistance -,	V _{GS} =2.5V, I _D =2.0A	Rds(on)	-	21.5	28	mΩ
Dynamic electrical characteristics						
Characteristic	Test condition	Symbol	Value		Unit	
		Symbol	Min.	Тур.	Max.	Unit
Input capacitance	V _{DS} =10V	Ciss	-	457	-	рF
Output capacitance	V _{GS} =0V	Coss	-	71	-	рF
Reverse transfer capacitance	f=1.0MHz	Crss	-	66	-	pF
Total gate charge	V _{DS} =10V	Qg	-	6.6	-	nC
Gate source charge	V _{GS} =4.5V	Qgs	-	0.4	-	nC
Gate drain charge	I _D =4.0A	Q_{gd}	-	2.0	-	nC
Switching characteristics						
Characteristic	Test condition	Symbol	Value		1	Unit
		-,	Min.	Тур.	Max.	
Turn on delay time	V _{DS} =10V	t _{d(on)}	-	4.1	-	ns
Turn on rise time	V _{GS} =4.5V	tr	-	11.6	-	ns
Turn off delay time	I _D =1.0A	t _{d(off)}	-	24	-	ns
Turn off fall time	R _G =3.3Ω		-	7.6	-	ns
Source drain diode characteristics		I	1			
Characteristic	Test condition	Symbol	Value		Unit	
		5911501	Min.	Тур.	Max.	Unit
Source drain current (body diode)	T _A =25°C	I _{SD}	-	-	0.2	А
Drain-source diode forward voltage	I _S =4.0A, V _{GS} =0V	Vsd	-	0.79	1.2	V

Notes:

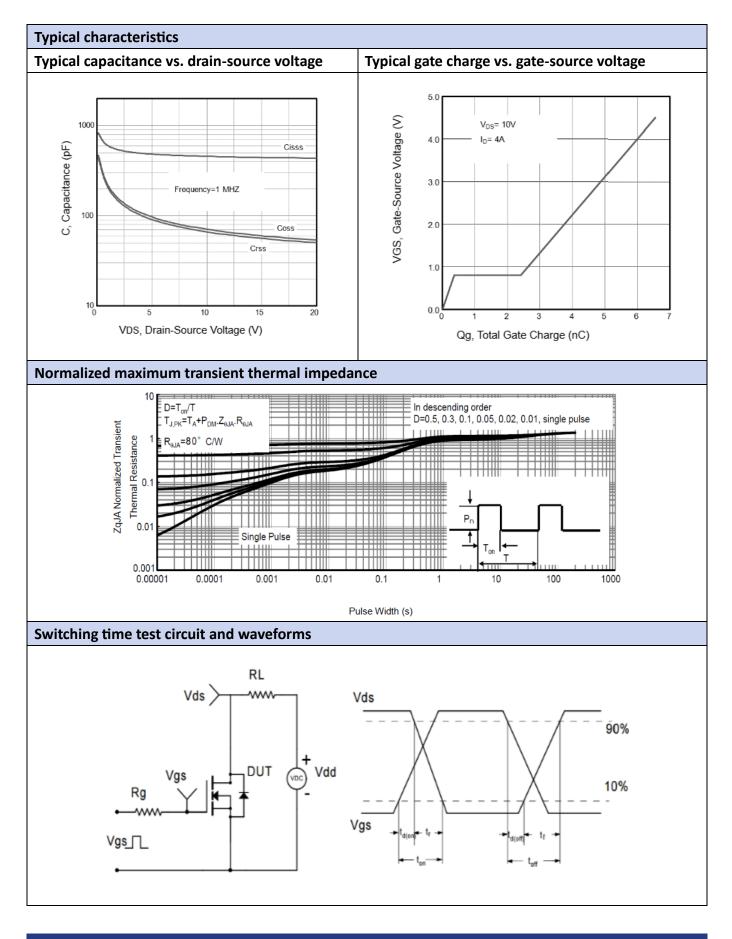
- 1) Pulse width limited by maximum allowable junction temperature
- 2) The value of $P_D \& R_{\theta JA}$ is measured with the device mounted on 1 in² FR-4 board with 2oz. copper, double sided, in a still air environment with $T_a=25^{\circ}C$
- 3) Pulse test; pulse width \leq 300ys, duty cycle \leq 2%

Stresses exceeding Maximum Ratings may damage the device. Maximum Ratings are stress ratings only. Functional operation above the Recommended Operating Conditions is not implied. Extended exposure to stresses above the Recommended Operating Conditions may affect device reliability.



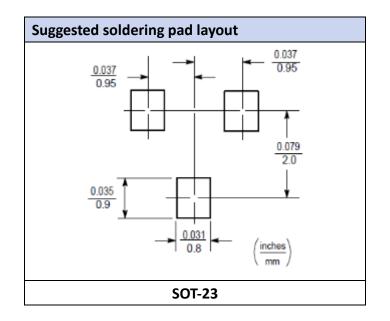








Ordering information								
Part Number	Package	Shipping Quantity	Dimensions					
AKS2300	SOT-23	3000 pcs / reel						



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